



SM840002

ClockWorks™ Dual 10-Gigabit/Gigabit Ethernet 62.5MHz, 125MHz, or 156.25MHz, Ultra-Low Jitter LVCMOS Clock Frequency Synthesizer

General Description

The SM840002 is a dual 10-Gigabit Ethernet and Gigabit Ethernet, 62.5MHz, 125MHz, or 156.25MHz LVCMOS clock frequency synthesizer and a member of the ClockWorks™ family of devices from Micrel. It provides a low-noise timing solution for high-speed, high-accuracy synthesis of clock signals. It includes a patented RotaryWave® architecture that provides a very stable clock with very-low noise.

Power supplies of either 2.5V or 3.3V are supported, with superior jitter and phase-noise performance. The device synthesizes a 62.5MHz, 125MHz, or 156.25MHz, low-noise LVCMOS output pair for Ethernet applications. The crystal reference frequency is 25MHz.

The SM840002 is an excellent replacement for IDT FemtoClocks®, with improved waveform integrity, and jitter.

Data sheets and support documentation can be found on Micrel's web site at: www.micrel.com.

Features

- Generates two LVCMOS outputs
- Operating supply modes:
 - Core/Output
 - 3.3V/3.3V, 2.5V/2.5V
- Typical phase jitter @156.25MHz~64 fs (1.875MHz – 20MHz)
- Crystal frequency: 25MHz
- 62.5MHz, 125MHz, or 156.25MHz output frequency
- Output Skew: 12ps (maximum)
- Phase Noise @ 156.25MHz:
 - 1KHz: –126dBc/Hz
 - 10KHz: –130dBc/Hz
 - 100KHz: –126dBc/Hz
 - 1MHz: –139dBc/Hz
 - 10MHz: –165dBc/Hz
 - 20MHz: –166dBc/Hz
- Temperature range: –40°C to +75°C
- Green-, RoHS-, and PFOS-compliant
- Available in 16-pin TSSOP

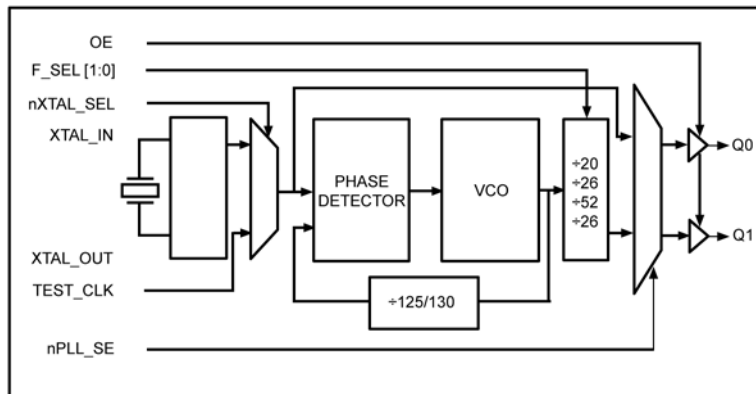
Applications

- Gigabit Ethernet
- 10-Gigabit Ethernet

ClockWorks is a trademark of Micrel, Inc.
RotaryWave is a registered trademark of Multigig, Inc.
FemtoClocks is a registered trademark of IDT, Inc.

Micrel Inc. • 2180 Fortune Drive • San Jose, CA 95131 • USA • tel +1 (408) 944-0800 • fax + 1 (408) 474-1000 • <http://www.micrel.com>

Block Diagram



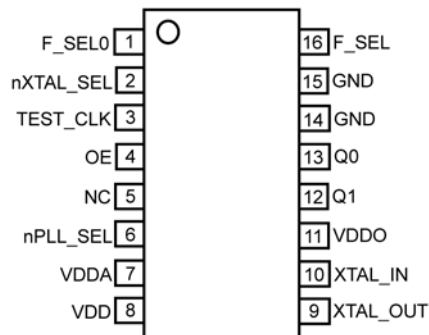
Ordering Information⁽¹⁾

Part Number	Package Type	Operating Range	Package Marking
SM840002KA	K-16	-40°C to +75°C	840002
SM840002KA TR ⁽²⁾	K-16	-40°C to +75°C	840002

Notes:

1. Devices are Green-, RoHS-, and PFOS-compliant.
2. Tape and Reel.

Pin Configuration



16-Pin TSSOP (K-16)

Pin Description

Pin Number	Pin Name	Type	Level	Pin Function
1	F_SEL0	I	Pull-Up	Frequency Select Pin. LVCMOS interface levels.
2	nXTAL_SEL	I	Pull-Down	Selects between XTAL and TEST_CLK Reference Input. When HIGH, selects TEST_CLK. When LOW, selects XTAL inputs. LVCMOS interface levels.
3	TEST_CLK	I	Pull-Down	Single-Ended LVCMOS Clock Input.
4	OE	I	Pull-Up	Output Enable. When HIGH, the outputs are active. When LOW, the outputs are in a high impedance state. LVCMOS interface levels.
5	NC			No Connect.
6	nPLL_SEL	I	Pull-Down	Selects between the VCO reference and the VCO Output. When LOW, the output is driven from the VCO output. When HIGH, the PLL is bypassed.
7	V _{DDA}	P		2.5V or 3.3V Output Power Supply. No filter resistor needed.
8	V _{DD}	P		2.5V or 3.3V Output Power Supply.
9	XTAL_OUT	O	12pF Crystal	Crystal Reference Output, no load caps needed.
10	XTAL_IN	I	12pF Crystal	Crystal Reference Input, no load caps needed.
11	V _{DDO}	P		2.5V or 3.3V Output Power Supply.
12	Q1	O	LVCMOS	Single-Ended Output Clock.
13	Q0	O	LVCMOS	Single-Ended Output Clock.
14	GND	P		Ground.
15	GND	P		Ground.
16	F_SEL1	I	Pull-up	Frequency Select Pin. LVCMOS interface levels.

Configuring the SM840002

Xtal Frequency (MHz)	F_SEL1	F_SEL0	M Divider	N Divider	Output Frequency (MHz)
25	0	0	125	20	156.25
25	0	1	130	26	125
25	1	0	130	52	62.5
25	1	1	130	26	125

Absolute Maximum Ratings⁽¹⁾

Supply Voltage (V_{DD})	+4.6V
Input Voltage (V_{IN})	-0.50V to $V_{DD}+0.5V$
Output Voltage (V_{OUT})	-0.50V to $V_{DD}+0.5V$
Lead Temperature (soldering, 20sec.)	260°C
Storage Temperature (T_s)	-65°C to +150°C

Operating Ratings⁽²⁾

Supply Voltage (V_{DDO})	+2.375V to +3.465V
Supply Voltage (V_{DD}, V_{DDA})	+2.375V to +3.465V
Ambient Temperature (T_A)	-40°C to +75°C
Junction Thermal Resistance	
TSSOP (θ_{JA})(Still Air)	127°C/W

DC Electrical Characteristics⁽³⁾

$V_{DDA} = V_{DD} = 2.5V \pm 5\%$, $V_{DDO} = 2.5V \pm 5\%$, $T_A = -40^\circ\text{C}$ to $+75^\circ\text{C}$, unless noted.

Symbol	Parameter	Condition	Min.	Typ.	Max.	Units
V_{DD}	Core Supply Voltage		2.375	2.50	2.625	V
V_{DDA}	Analog Supply Voltage		2.375	2.50	2.625	V
V_{DDO}	Output Supply Voltage		2.375	2.50	2.625	V
I_{DD}	Core Supply Current			0.1	1	mA
I_{DDA}	Analog Supply Current			48	55	mA
I_{DDO}	Output Supply Current	No Load		15	23	mA

$V_{DDA} = V_{DD} = 3.3V \pm 5\%$, $V_{DDO} = 3.3V \pm 5\%$, $T_A = -40^\circ\text{C}$ to $+75^\circ\text{C}$, unless noted.

Symbol	Parameter	Condition	Min.	Typ.	Max.	Units
V_{DD}	Core Supply Voltage		3.135	3.30	3.465	V
V_{DDA}	Analog Supply Voltage		3.135	3.30	3.465	V
V_{DDO}	Output Supply Voltage		3.135	3.30	3.465	V
I_{DD}	Core Supply Current			0.1	1	
I_{DDA}	Analog Supply Current			49	55	mA
I_{DDO}	Power Supply Current	No Load		25	32	mA

Notes:

1. Permanent device damage may occur if absolute maximum ratings are exceeded. This is a stress rating only and functional operation is not implied at conditions other than those detailed in the operational sections of this data sheet. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.
2. The data sheet limits are not guaranteed if the device is operated beyond the operating ratings.
3. The circuit is designed to meet the DC specifications shown in the above table after thermal equilibrium has been established.

LVC MOS DC Electrical Characteristics⁽³⁾

$V_{DDA} = V_{DD} = 2.5V$ or $3.3V \pm 5\%$, $V_{DDO} = 2.5V$ or $3.3V \pm 5\%$, $T_A = -40^\circ C$ to $+75^\circ C$, unless noted.

Symbol	Parameter	Condition	Min.	Typ.	Max.	Units
V_{IH}	Input HIGH Voltage		2		$V_{DD} + 0.3$	V
V_{IL}	Input LOW Voltage		-0.30		0.80	V
I_{IH}	Input HIGH Current	OE, F_SEL0, F_SEL1	$V_{DD} = V_{IN} = 3.465V$ or 2.625V		5	μA
		nPLL_SEL, MR, nXTAL_SEL, TEST_CLK	$V_{DD} = V_{IN} = 3.465V$ or 2.625V		150	μA
I_{IL}	Input LOW Current	OE, F_SEL0, F_SEL1	$V_{DD} = 3.465V$ or 2.625V $V_{IN} = 0V$	-150		μA
		nPLL_SEL, MR, nXTAL_SEL, TEST_CLK	$V_{DD} = 3.465V$ or 2.625V $V_{IN} = 0V$	-5		μA
V_{OH}	Output HIGH Voltage ⁽⁴⁾		$V_{DDO} = 3.3V \pm 5\%$	2.6		V
			$V_{DDO} = 2.5V \pm 5\%$	1.8		V
V_{OL}	Output LOW Voltage ⁽⁴⁾		$V_{DDO} = 3.3V \pm 5\%$ or $2.5V \pm 5\%$		0.5	V

AC Electrical Characteristics⁽⁵⁾

$V_{DDA} = V_{DD} = 2.5V$ or $3.3V \pm 5\%$, $V_{DDO} = 2.5V$ or $3.3V \pm 5\%$, $T_A = -40^\circ C$ to $+75^\circ C$, unless noted.

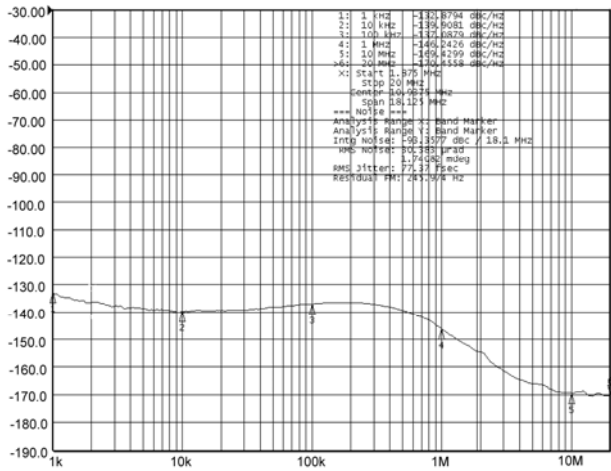
Symbol	Parameter	Condition	Min.	Typ.	Max.	Units
F_{OUT}	Output Frequency	F_SEL[1:0] = 00		156.25		MHz
F_{OUT}	Output Frequency	F_SEL[1:0] = 01		125		MHz
F_{OUT}	Output Frequency	F_SEL[1:0] = 10		62.5		MHz
F_{OUT}	Output Frequency	F_SEL[1:0] = 11		125		MHz
t_{SKEW}	Output Skew ⁽⁶⁾				12	ps
t_{JITTER}	RMS Phase Jitter	156.25MHz		0.064		ps
t_{JITTER}	RMS Phase Jitter	125MHz		0.065		ps
t_{JITTER}	RMS Phase Jitter	62.5MHz		0.077		ps
t_R/t_F	Output Rise/ Fall Time	20% to 80%	100		350	ps
O_{DC}	Output Duty Cycle		48	50	52	%

Notes:

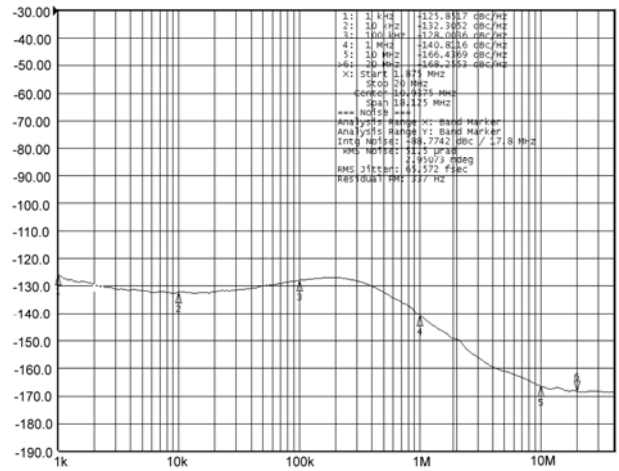
- Outputs terminated with 50Ω to $V_{DD}/2$. See Parameters measurements 3.3V load test circuit.
- The circuit is designed to meet the AC specifications shown in the above table(s) after thermal equilibrium has been established.
- Defined as skew between outputs at the same supply voltage and with equal load conditions; Measured at the output differential crossing points.

Crystal Characteristics

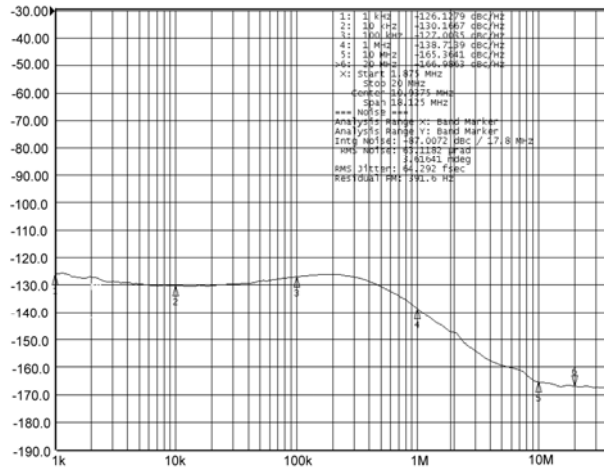
Parameter	Condition	Min.	Typ.	Max.	Units
Mode of Oscillation	12pF Load	Fundamental, Parallel Resonant			
Frequency			25		MHz
Equivalent Series Resistance (ESR)				50	Ω
Shunt Capacitor, C0			3	7	pF
Correlation Drive Level			100	300	μ W



Phase Noise Plot: 62.5MHz @ 3.3V



Phase Noise Plot: 125MHz @ 3.3V



Phase Noise Plot: 156.25MHz @ 3.3V

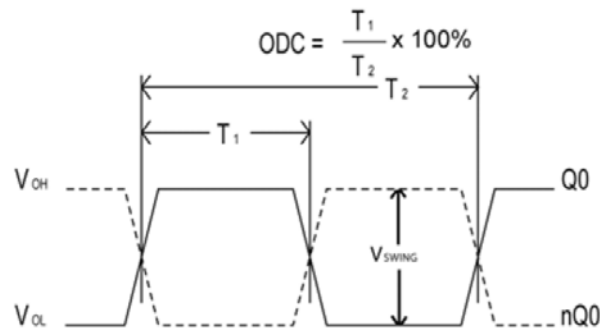


Figure 1. Duty Cycle Timing

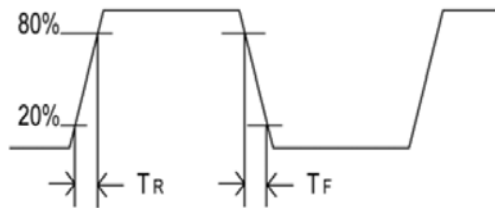


Figure 2. All Outputs Rise/Fall Time

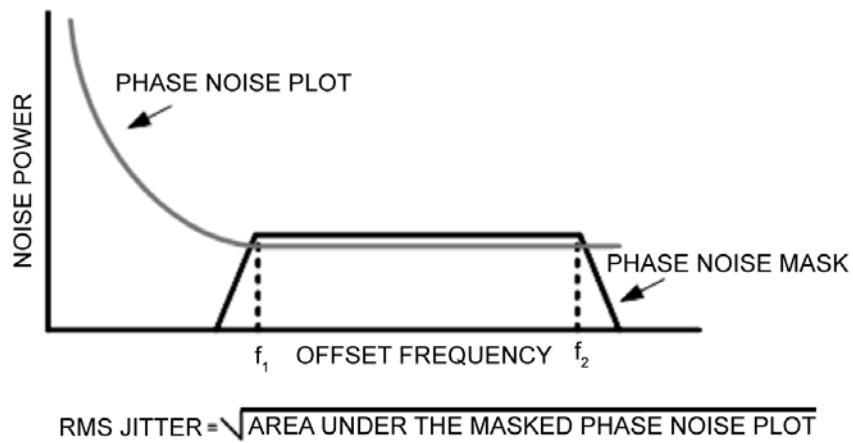


Figure 3. RMS Phase Noise/Jitter

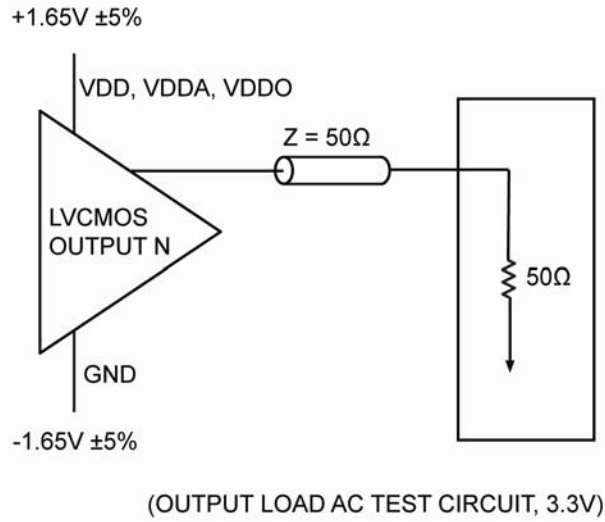


Figure 4. LVC MOS Output Load and Test Circuit

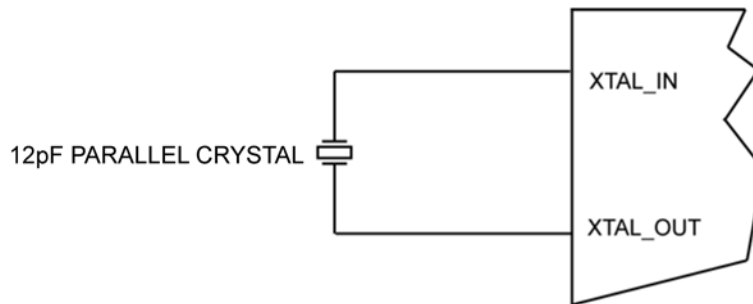
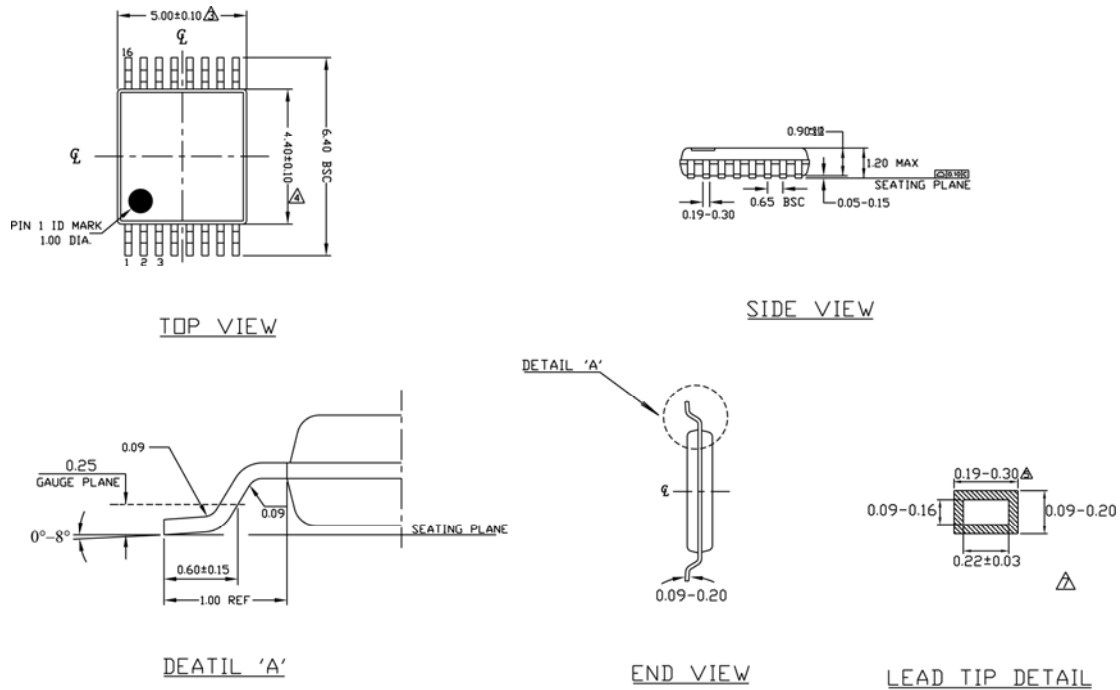


Figure 5. Crystal Input Interface

Package Information



Notes

1. ALL DIMENSIONS ARE IN MILLIMETERS (ANGLES IN DEGREES).
 2. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M-1994.
- △ DIMENSION DOES NOT INCLUDE MOLD FLASH, PROTRUSIONS OR GATE BURRS.
 - △ DIMENSION DOES NOT INCLUDE INTERNAL FLASH OR PROTRUSION.
 - △ DIMENSION DOES NOT INCLUDE DAMBAR PROTRUSION.
 - △ CROSS SECTION TO BE DETERMINED AT 0.10 TO 0.25MM FROM THE LEAD TIP.

16-Pin TSSOP (K-16)

MICREL, INC. 2180 FORTUNE DRIVE SAN JOSE, CA 95131 USA
 TEL +1 (408) 944-0800 FAX +1 (408) 474-1000 WEB <http://www.micrel.com>

Micrel makes no representations or warranties with respect to the accuracy or completeness of the information furnished in this data sheet. This information is not intended as a warranty and Micrel does not assume responsibility for its use. Micrel reserves the right to change circuitry, specifications and descriptions at any time without notice. No license, whether express, implied, arising by estoppel or otherwise, to any intellectual property rights is granted by this document. Except as provided in Micrel's terms and conditions of sale for such products, Micrel assumes no liability whatsoever, and Micrel disclaims any express or implied warranty relating to the sale and/or use of Micrel products including liability or warranties relating to fitness for a particular purpose, merchantability, or infringement of any patent, copyright or other intellectual property right.

Micrel Products are not designed or authorized for use as components in life support appliances, devices or systems where malfunction of a product can reasonably be expected to result in personal injury. Life support devices or systems are devices or systems that (a) are intended for surgical implant into the body or (b) support or sustain life, and whose failure to perform can be reasonably expected to result in a significant injury to the user. A Purchaser's use or sale of Micrel Products for use in life support appliances, devices or systems is a Purchaser's own risk and Purchaser agrees to fully indemnify Micrel for any damages resulting from such use or sale.

© 2010 Micrel, Incorporated.

Компания «Life Electronics» занимается поставками электронных компонентов импортного и отечественного производства от производителей и со складов крупных дистрибьюторов Европы, Америки и Азии.

С конца 2013 года компания активно расширяет линейку поставок компонентов по направлению коаксиальный кабель, кварцевые генераторы и конденсаторы (керамические, пленочные, электролитические), за счёт заключения дистрибьюторских договоров

Мы предлагаем:

- Конкуренспособные цены и скидки постоянным клиентам.
- Специальные условия для постоянных клиентов.
- Подбор аналогов.
- Поставку компонентов в любых объемах, удовлетворяющих вашим потребностям.
- Приемлемые сроки поставки, возможна ускоренная поставка.
- Доставку товара в любую точку России и стран СНГ.
- Комплексную поставку.
- Работу по проектам и поставку образцов.
- Формирование склада под заказчика.
- Сертификаты соответствия на поставляемую продукцию (по желанию клиента).
- Тестирование поставляемой продукции.
- Поставку компонентов, требующих военную и космическую приемку.
- Входной контроль качества.
- Наличие сертификата ISO.

В составе нашей компании организован Конструкторский отдел, призванный помогать разработчикам, и инженерам.

Конструкторский отдел помогает осуществить:

- Регистрацию проекта у производителя компонентов.
- Техническую поддержку проекта.
- Защиту от снятия компонента с производства.
- Оценку стоимости проекта по компонентам.
- Изготовление тестовой платы монтаж и пусконаладочные работы.



Тел: +7 (812) 336 43 04 (многоканальный)

Email: org@lifeelectronics.ru